

ALUMINUM ELECTROLYTIC CAPACITORS

nichicon

WF

Chip Type, Low Impedance
series



- Chip type, low impedance temperature range up to +105°C.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2002/95/EC).



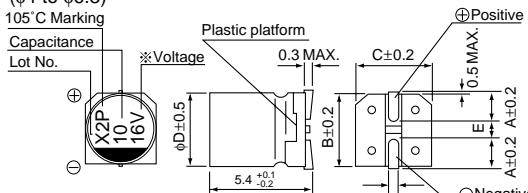
WG ← Low Impedance WF → Low Impedance WT

■ Specifications

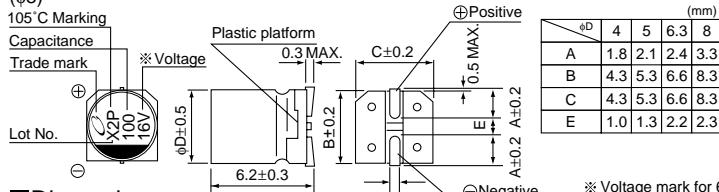
Item	Performance Characteristics										
Category Temperature Range	−55 to +105°C										
Rated Voltage Range	6.3 to 35V										
Rated Capacitance Range	1 to 220μF										
Capacitance Tolerance	±20% at 120Hz, 20°C										
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01CV or 3 (μA), whichever is greater. Measurement frequency : 120Hz, Temperature : 20°C										
Tangent of loss angle (tan δ)	Rated voltage (V)	6.3	10	16	25	35					
	tan δ (MAX.)	0.22	0.19	0.16	0.14	0.12					
Stability at Low Temperature	Measurement frequency : 120Hz										
	Rated voltage (V)	6.3	10	16	25	35					
	Impedance ratio Z-25°C / Z+20°C	2	2	2	2	2					
	ZT / Z20 (MAX.) Z-55°C / Z+20°C	4	4	3	3	3					
Endurance	The specifications listed at right shall be met when the capacitors are restored to 20°C after the rated voltage is applied for 1000 hours at 105°C.										
	Capacitance change	Within ±20% of the initial capacitance value									
	tan δ	200% or less than the initial specified value									
	Leakage current	Less than or equal to the initial specified value									
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.										
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.										
	Capacitance change	Within ±10% of the initial capacitance value									
	tan δ	Less than or equal to the initial specified value									
	Leakage current	Less than or equal to the initial specified value									
Marking	Black print on the case top.										

■ Chip Type

(d4 to φ6.3)



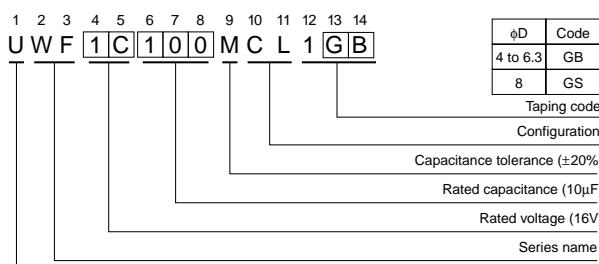
(φ8)



■ Dimensions

Cap. (μF)	Code	V	6.3		10		16		25		35					
		0J	1A	1C	1E	1V										
1	010										4	5.0	50			
1.5	1R5										4	5.0	50			
2.2	2R2										4	5.0	50			
3.3	3R3										4	5.0	50			
4.7	4R7								4	5.0	50	4	5.0	50		
6.8	6R8							4	5.0	50	5	2.6	80			
10	100						4	5.0	50	5	2.6	80	5	2.6	80	
15	150						5	2.6	80	6.3	1.3	115	6.3	1.3	115	
22	220	4	5.0	50	5	2.6	80	5	2.6	80	6.3	1.3	115	6.3	1.3	115
33	330	5	2.6	80	5	2.6	80	6.3	1.3	115	6.3	1.3	115	8	0.8	150
47	470	5	2.6	80	6.3	1.3	115	6.3	1.3	115	8	0.8	150	8	0.8	150
68	680	6.3	1.3	115	6.3	1.3	115	8	0.8	150	8	0.8	150			
100	101	6.3	1.3	115	8	0.8	150	8	0.8	150						
150	151	8	0.8	150	8	0.8	150									
220	221	8	0.8	150												

Type numbering system (Example : 16V 10μF)



* Voltage mark for 6.3V is 6V.

● Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.35	0.50	0.64	0.83	1.00

Max. Impedance (Ω) at 20°C 100kHz
Rated ripple current (mA rms) at 105°C 100kHz

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please select UJ(p.102) series if high C/V products are required.
- Please refer to page 3 for the minimum order quantity.

CAT.8100Y